TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (Ultra High speed U-MOSIII)

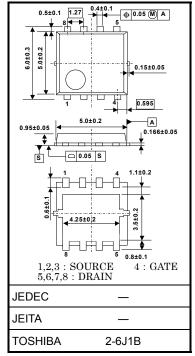
TPCA8003-H

High Speed and High Efficiency DC-DC Converters Notebook PC Applications Portable Equipment Applications

- Small footprint due to small and thin package
- High speed switching
- Small gate charge: $Q_g = 25 \text{ nC}$ (typ.)
- Low drain-source ON resistance: R_{DS} (ON) = 5.1 m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 60S$ (typ.)
- Low leakage current: $IDSS = 10 \ \mu A \ (max) \ (VDS = 30 \ V)$
- Enhancement mode: V_{th} = 1.1 to 2.3 V (V_{DS} = 10 V, I_{D} = 1 mA)

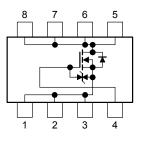
Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	30	V	
Drain-gate voltage (R	lgs = 20 kΩ)	V _{DGR}	30	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	۱ _D	35	А	
Drain current	Pulsed (Note 1)	I _{DP}	105	~	
Drain power dissipati	on (Tc=25°C)	PD	P _D 45		
Drain power dissipati	on (t = 10 s) (Note 2a)	PD	2.8	W	
Drain power dissipation	on (t = 10 s) (Note 2b)	PD	1.6	W	
Single pulse avalanch	ne energy (Note 3)	Eas	159	mJ	
Avalanche current		I _{AR}	35	А	
Repetitive avalanche	energy ⁻c=25°C) (Note 4)	Ear	4.5	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	–55 to 150	°C	



Weight: 0.080 g (typ.)

Circuit Configuration



Note: For (Note 1), (Note 2), (Note 3), (Note 4), please refer to the next page.

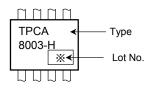
This transistor is an electrostatic sensitive device. Please handle with caution.

Unit: mm

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case (Tc=25°C)	R _{th (ch-c)}	2.78	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	44.6	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	78.1	°C/W

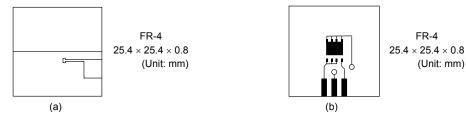
Marking (Note 5)



Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)



Note 3: $V_{DD} = 24 \text{ V}$, $T_{ch} = 25^{\circ}C$ (initial), L = 0.1 mH, $R_G = 25 \Omega$, $I_{AR} = 35 \text{ A}$

Note 4: Repetitive rating: pulse width limited by max channel temperature

Note 5: * Weekly code: (Three digits)



Week of manufacture

_(01 for first week of year, continues up to 52 or 53)

Year of manufacture
 (One low-order digits of calendar year)

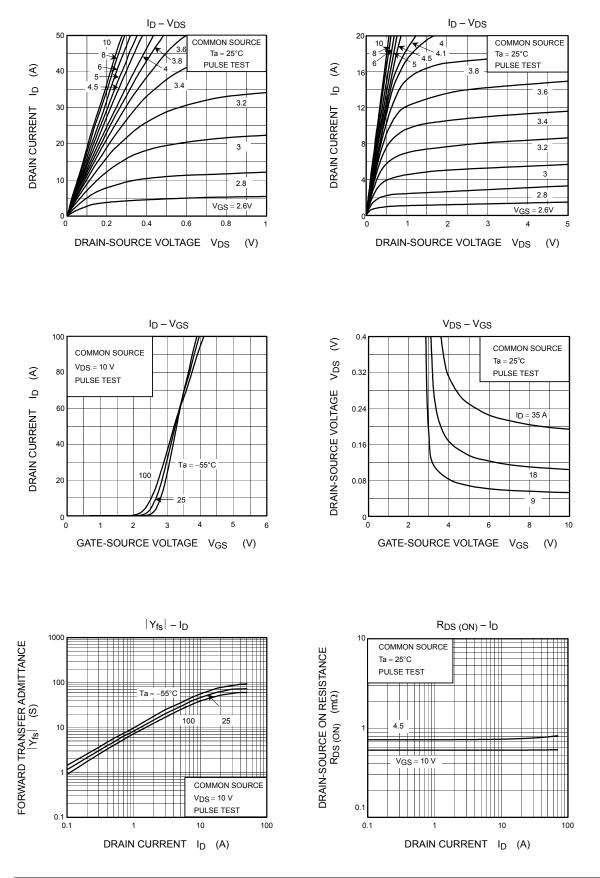
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS}=\pm 16~V,~V_{DS}=0~V$	_	_	±10	μΑ
Drain cut-OFF cu	ırrent	I _{DSS}	$V_{DS}=30~V,~V_{GS}=0~V$	_	_	10	μA
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	30	_	_	V
	akuown voltage	V (BR) DSX	$I_D=10\ mA,\ V_{GS}=-20\ V$	15	15 — — 1.1 — 2.3 — 7.3 9.5 — 5.1 6.6 30 60 — — 1465 — — 175 — — 610 — — 4 —	v	
Gate threshold ve	oltage	V _{th}	$V_{DS}=10~V,~I_{D}=1~mA$	1.1	_	2.3	V
	registance	Ppp (on)	$V_{GS}=4.5 \ V, \ I_D=18 \ A$		7.3	9.5	
Drain-source ON resistance		R _{DS} (ON)	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 18 \text{ A}$	_	5.1	6.6	mΩ
Forward transfer admittance		Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 18 \text{ A}$	30	60	_	S
Input capacitance	e	C _{iss}		_	1465	_	
Reverse transfer capacitance		C _{rss}	V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz	_	175	_	pF
Output capacitance		C _{oss}		_	610	_	
Switching time	Rise time	tr	$V_{GS} \stackrel{10}{}_{0}V \prod_{V \in S} \stackrel{I_{D} = 18 \text{ A}}{\overset{I_{D} = 18 \text$	_	4	_	ns
	Turn-ON time	t _{on}			11	_	
	Fall time	t _f			10	_	
	Turn-OFF time	t _{off}	$V_{DD}\simeq 15~V \label{eq:VDD}$ Duty \leq 1%, $t_W=10~\mu s$		36	_	
Total gate charge	Fotal gate charge		$V_{DD}\simeq 24~V,~V_{GS}=10~V,~I_D=35~A$		25	—	
(gate-source plus		Qg	$V_{DD}\simeq 24~V,~V_{GS}=5~V,~I_D=35~A$	= 35 A — 13 -		_	
Gate-source charge 1		Q _{gs1}			5.8		nC
Gate-drain ("miller") charge		Q _{gd}	$V_{DD}\simeq 24~V,~V_{GS}=10~V,~I_D=35~A$		5.1	_	-
Gate switch charge		Q _{SW}		_	8.4		

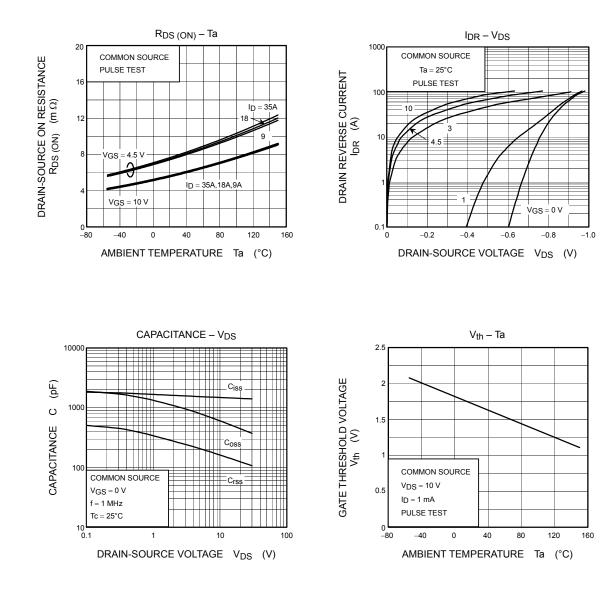
Source-Drain Ratings and Characteristics ($Ta = 25^{\circ}C$)

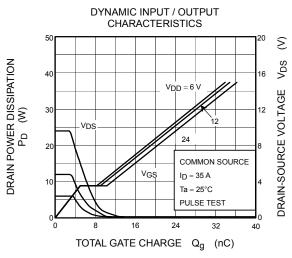
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Drain reverse current	Pulse	(Note 1)	I _{DRP}	—	_		105	А
Forward voltage (diode)			V _{DSF}	$I_{DR} = 35$ A, $V_{GS} = 0$ V		_	-1.2	V

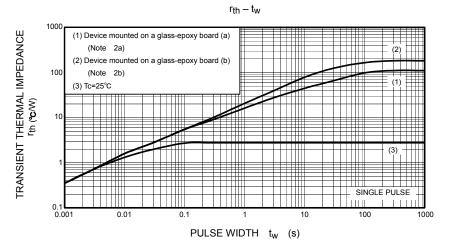
TOSHIBA

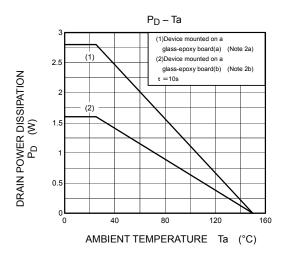


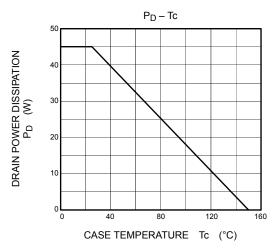
TOSHIBA

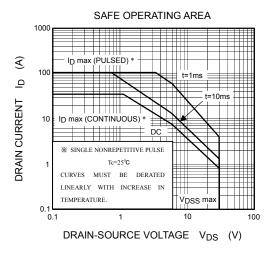












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